# DATASHEET

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Manufacturer:

Hatteland Technology AS

Product: Type:

# Compact Fanless Computer

**HT B30Kx STC-yzz-Ezzzzz (Short Depth model)** (where x=CPU type, y=OS, z=Configuration)

# Last Revised: **11** A Revision#: **29**

11 Apr 2022 29

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HATTELAND TECHNOLOGY

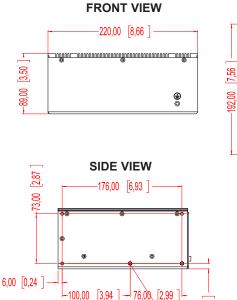
# **Compact Fanless Computer**

# **Overview:**

The HT B30 range is based on the latest Intel chipset and Skylake processor platform, delivering even more power for maritime technology developers to design and build high-end vessel control and monitoring solutions that enable safer and more effecient maritime operations.

HT B30 computers are available in two new form factors, short depth and long depth, allowing for flexible installation options including 3U rack mounting in pairs. Using the same system architecture as our new, second generation Series X Panel Computers, the HT B30 range offers significant processing speed and graphical performance improvements, which when combined with multiple-drive solid state storage and silent, fanless operation, positioning it among the most advanced computing platforms for maritime applications.

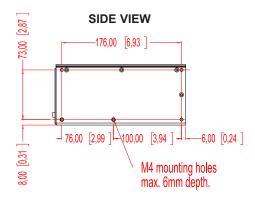
HT B30 computers can be delivered with a choice of Intel® Core<sup>TM</sup> / Celeron® processors, up to i7. Graphical output is handled by 1 x DVI-I, 1 x DVI-D and 1 x Display Port (DP++ 1.2) while standard interfaces include 4 x Ethernet Ports, 4 x USB2.0 and 4 x USB3.0. The HT B30 platform also supports a wide range of interface modules such as CAN/NMEA COM/COM and DIO, ensuring it is ready off-the-shelf for all maritime applications. In addition, HT B30K range of computers features a lightweight, fully enclosed aluminium chassis and comes dual DC power input.





0,31

8,0



BACK VIEW





Shown with AMP Audio Option

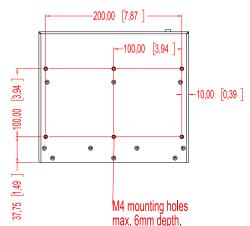
0,13

3,20



Shown with 3 x Factory Mounted Module Options

# BOTTOM VIEW



Dimensions might be shown with or without decimals and indicated as mm [inches]. Tolerance on drawings is +/- 1mm. For accurate measurements, check relevant DWG file.

# **SPECIFICATIONS**

Note: All specifications are subject to change without prior notice! Please visit www.hattelandtechnology.com for the latest electronic version.



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#### TECHNICAL DESCRIPTION **Computer Specifications: (Standard model) External Connector Type:** None or Customized image - See table below 1 x Intel® Core<sup>™</sup> - See table below 2 x SO-DIMM SLOT DDR4-2133, Max 2x16GB - See table below 1 x SSD m.2 - See table below for sizes 1 x SSD (COperated below for sizes Operating System Processor Memory/RAMStorage internal 1 x SOU III.2 - See table below for SiZES 1 x SDXC (SDcard) slot Intel® HD Graphics 510 (OpenGL 4.4)/520 (OpenGL 4.5), DirectX 12.0, OpenCL 2.0 3 independent displays (valid combinations: ref Intel datasheet) DP = 4096x2304@60Hz. DVI-I/D = 1920x1200@60Hz Integrated in 6th Generation Intel® Core<sup>™</sup> U-series processor ACPI curport Media Storage 1 x SDcard Slot 1 x DVI-I\*\*\* + 1 DVI-D + 1 x DP++ 1.2 Graphics Graphics Res. System ChipsetBIOS ACPI support : ACPI support : 1 x 10/100/1000Mbps, Intel® Gigabit LAN : 1 x 10/100/1000Mbps, Intel® Gigabit LAN : 1 x 10/100/1000Mbps, Realtek Gigabit LAN : 1 x 10/100/1000Mbps, Realtek Gigabit LAN 1 x RJ-45, Teaming 1 x RJ-45, Teaming 1 x RJ-45, Teaming 1 x RJ-45, Teaming • Ethernet #1 • Ethernet #2 • Ethernet #3 Ethernet #4 4 x USB Type A 4 x USB Type A 4 x USB2.0 (<5m) 4 x USB3.0 (<3m) USB Ports #1 USB Ports #2 Power Manager ACPI S3/S4 Prover Manager : ACP1 53/54 Watchdog Timer : 256 Segments, 0, 1, 2...255 sec/min RTC : 0.55/day\*\* H/W Status Mont. : TPM2.0, Firmware Raid, Temperatures, voltages, Battery load status Alarm, cooling fan status\*. Auto throttling control if CPU overheats Battery : Normal operational conditions: life time >5 year, worst case conditions(@70C, 24/7): life time >2 year Cooling FAN status, not applicable for system without CPU/system FAN. \* Degrue d accuracy may be dependent of the actual implementation/convironment and may require calibration to be within credified boundaries RTC H/W Status Mont. Battery \*\*\* Required accuracy may be dependent of the actual implementation/environment and may require calibration to be within specified boundaries. \*\*\* Depending on manufactured date of unit, the DVI-I connector are present on unit, but it will not support VGA ref: https://www.hattelandtechnology.com/product-notifications/ht-b30-configuration-update-due-to-component-shortage **Power Specifications: Power Supply options:** Dual DC Input 24VDC, 24V nom, Galvanic isolated, automatic switch between power source Power Consumption\*\* - Operating : 43W (typ)\* - 75W (max) - \*at 25% load. Max Allowed External USB load = 10W. 2 x 2-pin Terminal Block 5.08 Available Computer Configurations: Туре Description Size/Specification - 2.4GHz / 3GHz 2/4 @15W, 403 GFLOPS, Chipset: Intel® HD 520 - 2.6GHz / 3.4GHz 2/4 @15W, 403 GFLOPS, Chipset: Intel® HD 520 - 2.0GHz 2/2 @15W, 173 GFLOPS, Chipset: Intel® HD 510 1 x Intel® Core<sup>™</sup> i5-6300U (2 physical core / 4 thread) or Intel® Core<sup>™</sup> i7-6600U (2 physical core / 4 thread) or Intel® Celeron® 3955U (2 physical core / 2 thread) CPU Dual Channel, DDR4 SO-DIMM, 2 slots available - 2x4GB (Standard), 2x8GB, 2x16GB (Max) Memory - 240GB (599TBW),480GB (945TBW),960GB (1750TBW) Review "SSD Selection Guide" in User Manual Storage 1 x SSD m.2 SATA Windows® 7 Pro/Ult. Embedded Systems\*, Windows® Emb. Standard 7 (Toolkit & Runtime) All Versions\*\*, Windows® 10 IoT Enterprise 2019 LTSC\*\*\* Linux (Skylake: kernel 4.4 or later). \*Product Distribution End Date September 2024. \*\*Product Distribution End Date July 2025. \*\*\*Product Distribution End Date January 2029. OS Option 32/64bit where applicable **Factory Mounted Options: Available Accessories:** HT 00262 OPT-A1: 4 x RS-422/RS-485 isolated, USB ext. module HT 00263 OPT-A1: 4 x RS-232 COM non-isolated, USB ext. module HT 00263 OPT-A1: 1 x CAN isolated, 2 channel, USB ext. module HT 00273 OPT-A1: 4 x Digital IN/OUT isolated, USB ext. module HT 00274 OPT-A1: 2 x LAN 10/100Mbps, RJ45, USB ext. module HT 00228 OPT-A1: 1 x Mounting Plate with cable relief, RAL9011 HT MBK STD-A2: 1 x Mounting Bracket Kit\*\* HT DE STD A1: 1 x Cable Retaining Chairs (Kit\*\*) • 1 or 2 x PCA200828-1 (4 x COM RS-422/485 isolated NMEA 4 channel) module • 1 x ZIA0001310-B (1 x CAN isolated, 2 channel) module 1 x ZIA0001310-SLCAN (1 x CAN isolated, 2 channel, socketCAN) module 1 x PCA100297-1 (4 x Digital Input/Output isolated) module 1 x PCA100298-1 (LAN 10/100Mbps, 2 ports (RJ45) module 1 x VSD203134-1 (2W Amplified Audio out via DB9F) HT MBK STD-A2: 1 x Mounting Bracket Kit\*\* HT RET STD-A1: 1 x Cable Retainer/Relief Kit\*\* HT RMK STD-A1: 1 x 2U Rack Mount Kit RAL9011 HT RMK STD-H1: 1 x 2U Rack Mount Kit w/Handles, RAL9011 HT SRK STD-A2: 1 x 3U 19" Slide Rack Mount Kit (For 1 or 2 x HTB30) SF-41-20: 2 x 20" ball bearing sliding rail kit for 19" Rack\* SF-41-26: 2 x 26" ball bearing sliding rail kit for 19" Rack\* SF-41-26: 2 x 26" ball bearing sliding rail kit for 19" Rack\* • 1, 2 or 3 x PCA100309-1: Dual Isolated RS-232, 2xDB9M module Recessed Power Button Option Recessed Reset Button Option Reset Button Option Variations of Storage Devices, RAM Memory and Operating System Contact us for possible combinations. Review separate datasheet for more info. JH COIMF A-A: 1 x USB Cable 1m, Type A to Chassis mount receptacle HT 00300 MSOS: OS options: https://www.hattelandtechnology.com/os \* Must be combined with HT SRK STD-A2 \*\* Included with delivery

#### MECHANICAL DESCRIPTION

### **Physical Specifications:**

- W:220.00 [8.66"] x H:89.00 [3.50"] x D:192.00 [7.56"] mm [inch]
- Weight: 2.5 kg / 5.5lbs
- Aluminium Cooling Chassis
- Includes: Mounting Bracket Kit, USB + DP/HDMI Retainers, Cable Relief Retainer
- Power (or Reset=optional model) Button, Power LED, Activity LED SSD

\*\*Power Consumption: Numbers are specified as the unit is delivered from factory. All additional installed equipment like USB, PCIe and similar loads have to be added to power consumption. Note that total extra load have to be multiplied by 1.5 to compensate for efficiency in internal power converters. Typical power consumption varies a lot with computer load. We measure with 25% of max computer load.

# Environmental Considerations:

		-
<ul> <li>Operating</li> </ul>	: Temperature -15°C to +55°C	
Storage	: Temperature -20°C to +60°C	

- Humidity
   : Up to 95% (Operating / Storage)

   Shock Vibration
   : 5g/11ms 0.7g (IEC 60945 / IACS E10)

   Air Pressure Maximum Altitude
   : Operating: 4000m Storage: 12912m

   Air Pressure Maximum Altitude
   : Operating: 3000m Storage: 3000m
- (Bonded)
- Compass Safe Distance : Standard: 30cm - Steering: 25cm

### Lifetime Considerations:

Even though the test conditions for bridge units provide for a maximum operating temperature of 55°C, continuous operation of all electronic components should, if possible, take place at ambient temperatures of only 25°C. This is a necessary prerequisite for long life and low service costs.

#### 8 <u>CER</u>TIFICATES

IEC 60945 4th (EN 60945:2002) ClassNK - Nippon Kaiji Kyokai

IACS E10 EN55024 CCS - China Classification Society

These products have been tested / type approved by the following classification societies: EN55022, Class A ABS - American Bureau of Shipping

EU RO MR - Mutual Recognition **BV** - Bureau Veritas